

# **Mitigation of Chromium Impurity Effects and Degradation in SOFCs**

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**Boston University**

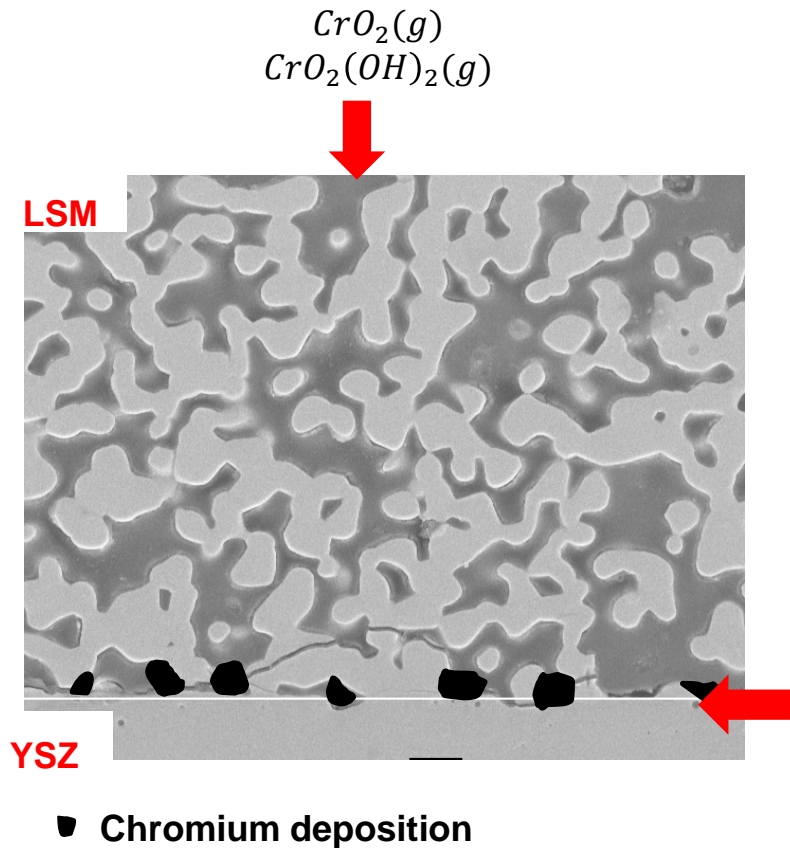
# Outline

- Motivation and goals
- Understanding of Cr impurity attack – role of current density, humidity, temperature
  - Effect of Cr impurity using half cells and complete cells
- Protective coatings
- Ongoing work
- Summary and conclusions

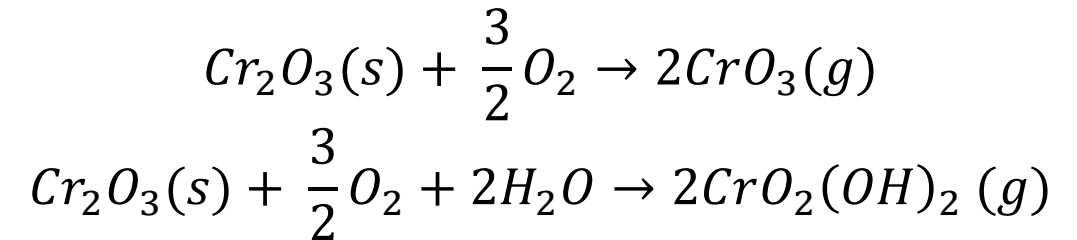
# Motivation and Goals

- Understand the mechanism and kinetics of Cr impurity attack at the SOFC cathode
- Develop effective strategies to combat Cr impurity effects:
  - Protective coatings
  - Cathode compositional modifications

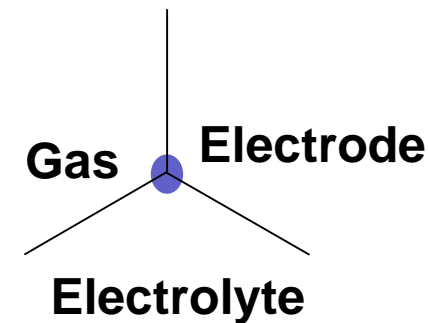
# Current Understanding of Cr Attack Mechanism



- Source of Cr from interconnect and BOP:



Triple-Phase- Boundary:

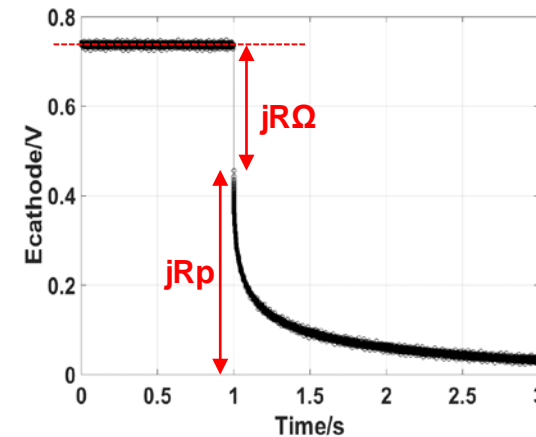
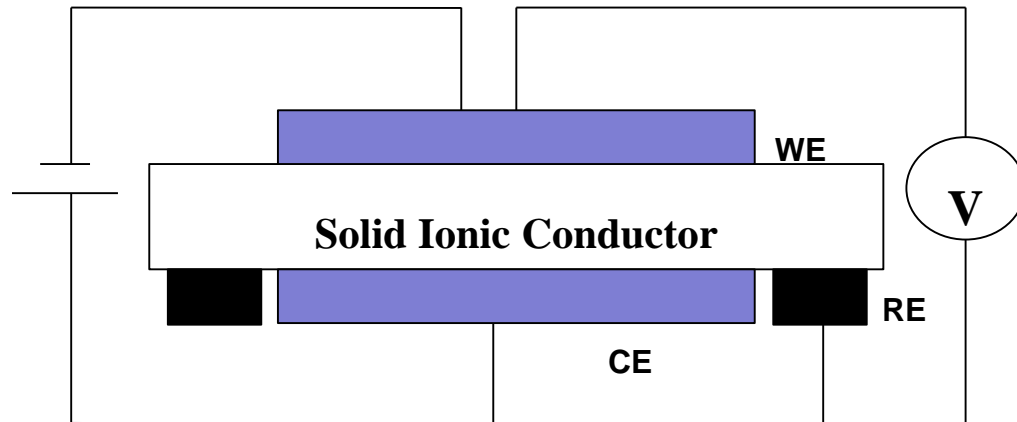


# Kinetic Studies: Electrochemical Measurement Tools

- Half-cells in contact with Cr source
- Complete SOFCs in contact with Cr source
- SEM-EDX analysis

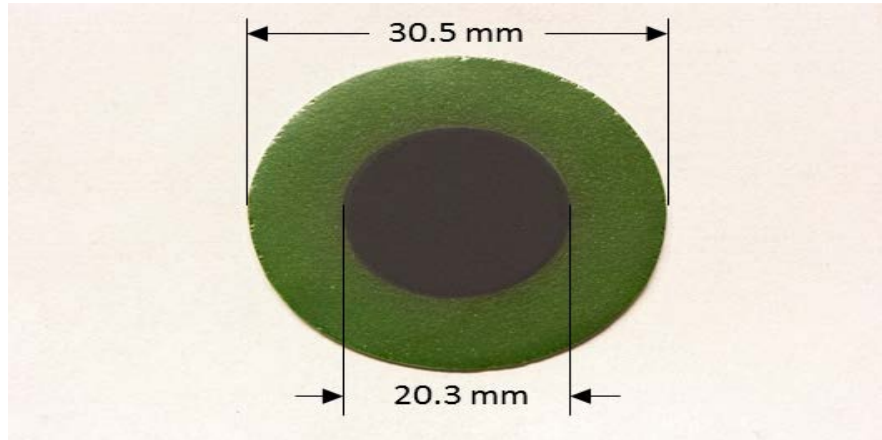
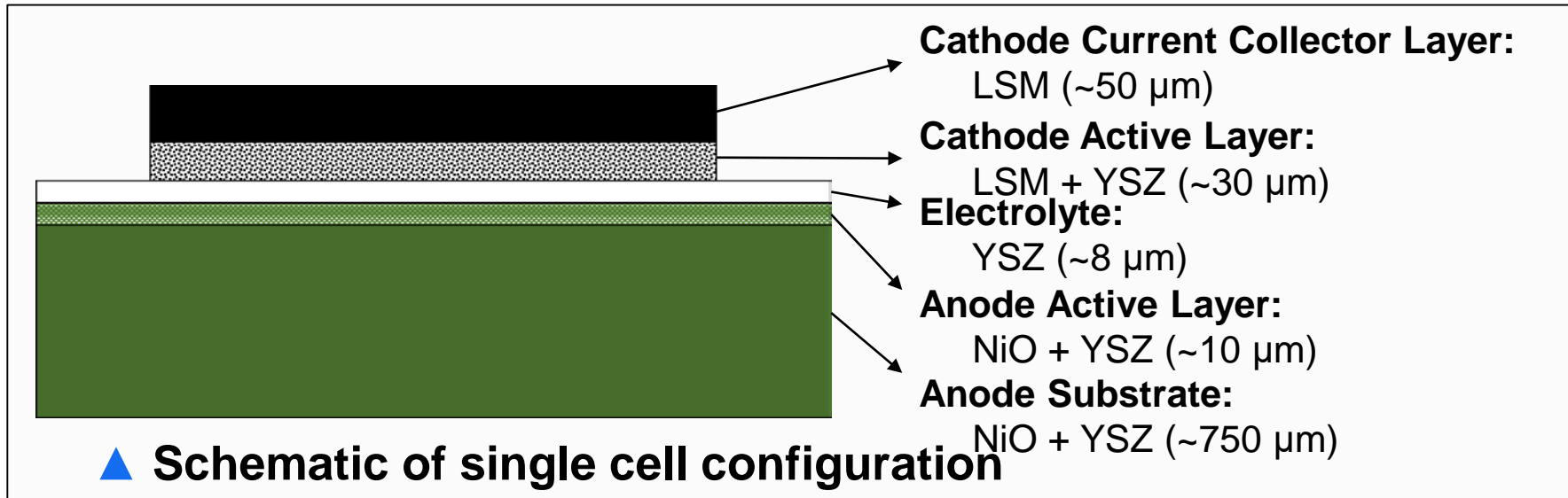
# Cell Configuration: Half-cell measurements

- Galvanostatic Current Interruption Technique(GCI)

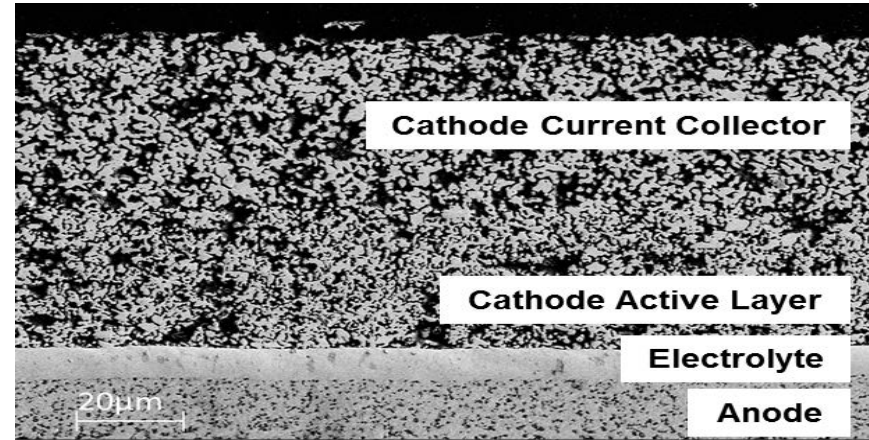


Parameter	Units	Description
$E_{\text{cathode}}$	V	The cathodic potential
$R_p$	$\Omega \cdot \text{cm}^2$	The polarization resistance
$R_\Omega$	$\Omega \cdot \text{cm}^2$	The ohmic resistance

# Cell Configuration: Complete Cells



▲ As-sintered cell



▲ SEM micrograph of cell cross section

# Results & discussions

Effect of Current

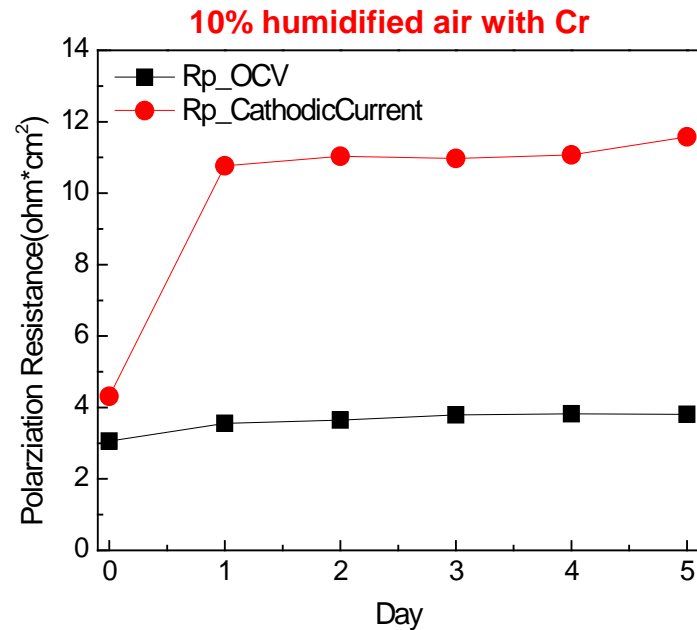
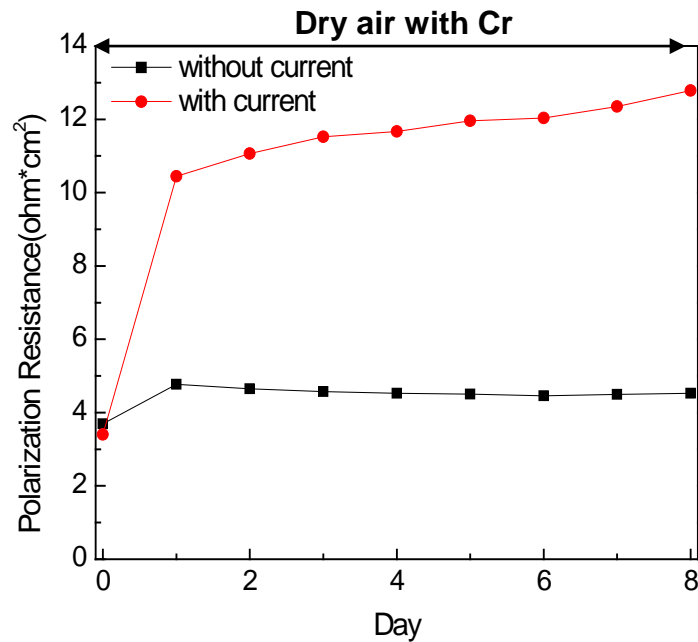
Effect of Humidity

Effect of Time under Cathodic Current

Effect of Temperature



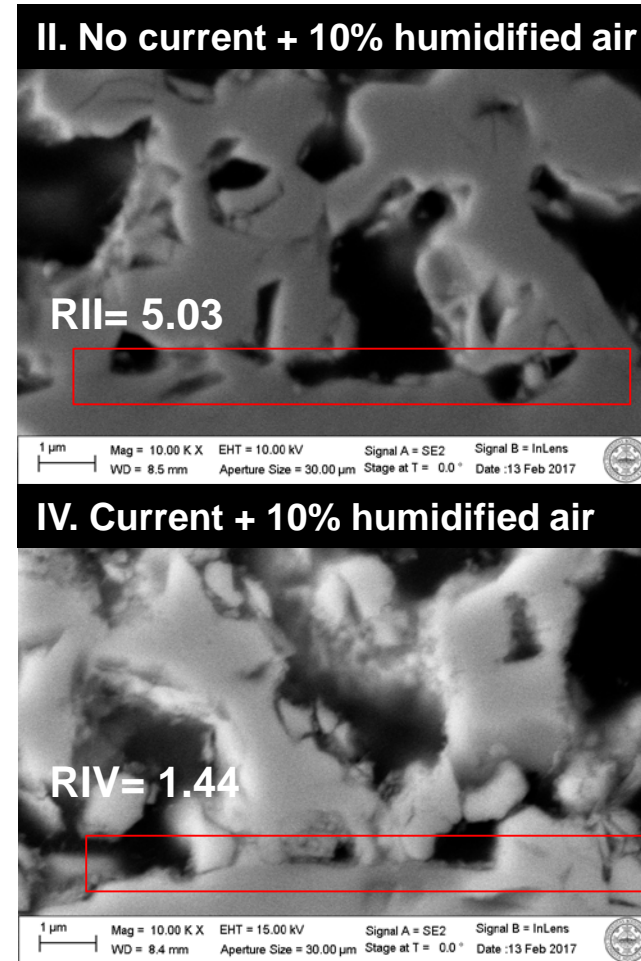
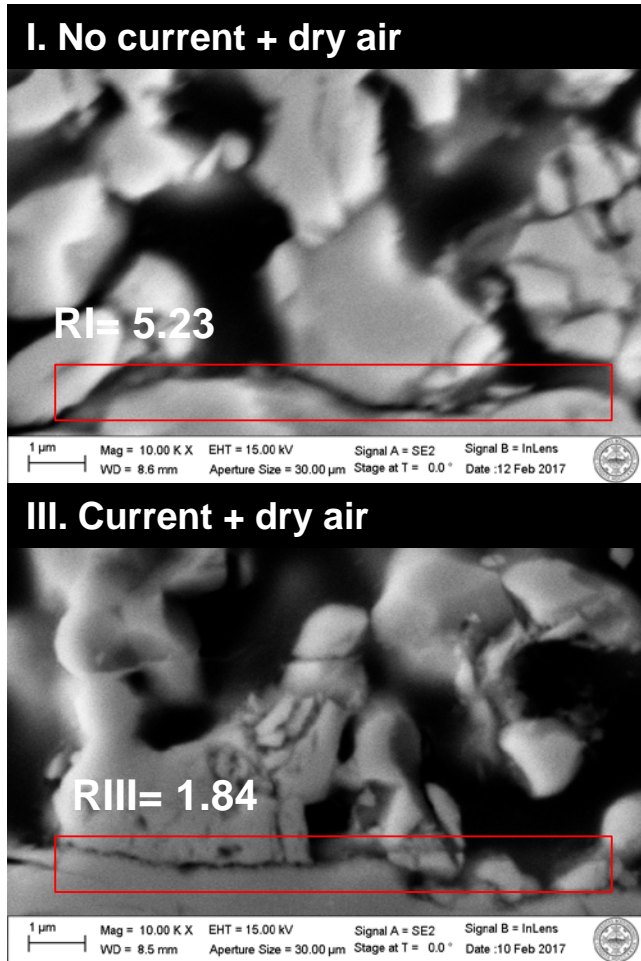
# Effect of Current and Humidity (Cathode Polarization): Half-Cells



- **Without current:**
  - The polarization resistance was stable.
- **With current:**
  - The polarization resistance increased dramatically on the first day in dry air and 10% humidified air.

$$R = \frac{(La_{L\alpha} + Cr_{K\alpha})}{La_{L\alpha}}$$

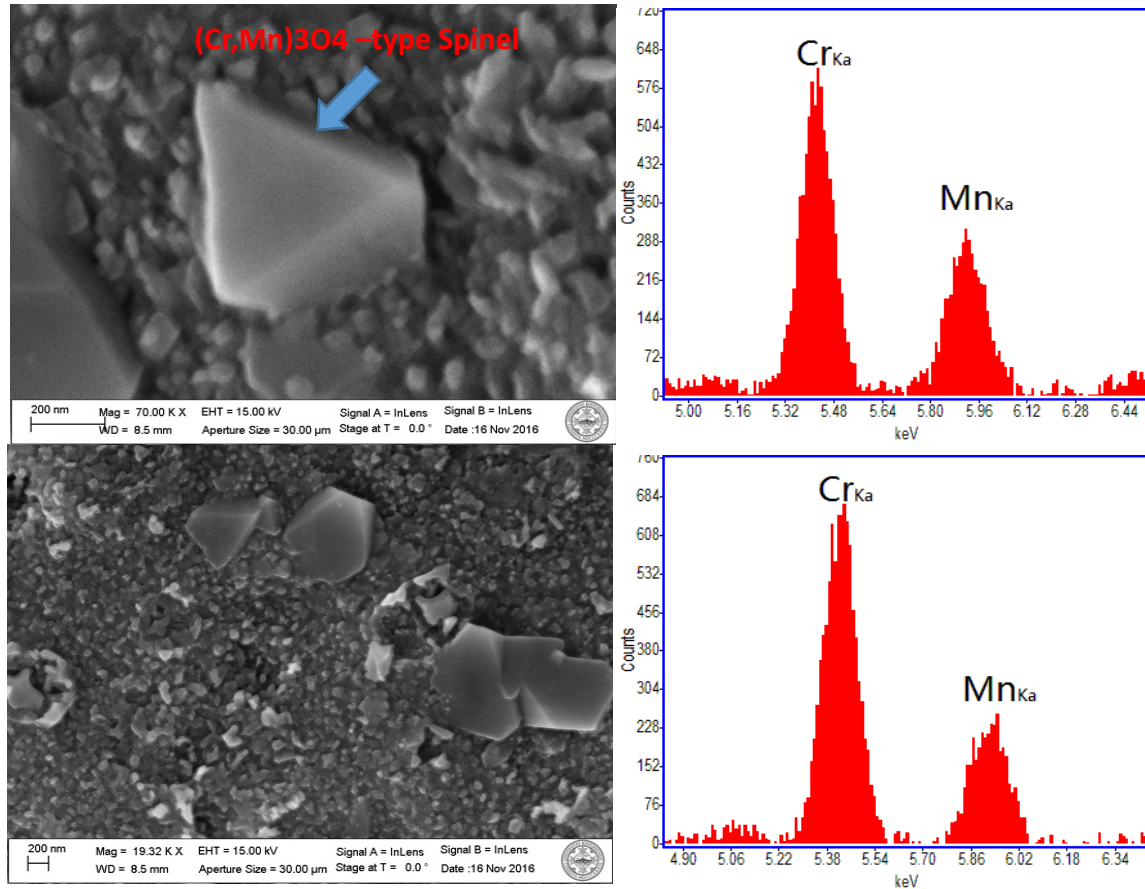
# Microstructure-TPBs



➤  $R_I < R_{II} < R_{III} < R_{IV}$

➤ Chromium deposition is heaviest in  $R_{IV}$

# Cathode-Electrolyte Interface Microstructure after HCl Etching of Cathode (Half Cells)

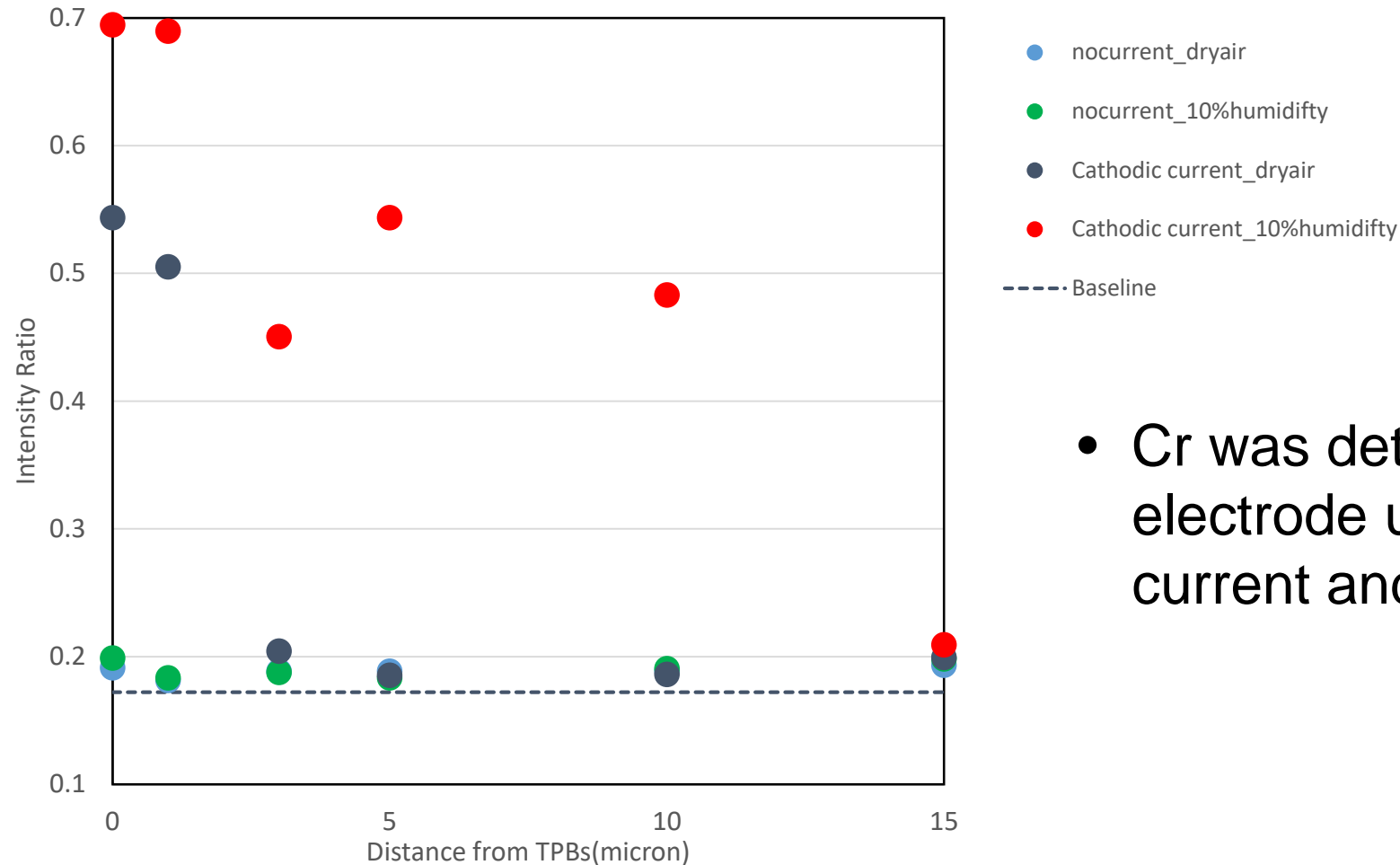


- The faceted grains:  
 $\text{Mn}(\text{Mn},\text{Cr})_2\text{O}_4^1$
- The atomic ratio Cr:Mn = 2 on the large grains

- The atomic ratio Cr:Mn > 2 over the whole area.
- The small fine grains: Cr-rich  
 $(\text{Cr},\text{Mn})_3\text{O}_4$  and Cr-rich phase such as  $\text{Cr}_2\text{O}_3$  could be detected.

1. Badwal S P S, Deller R, Foger K, et al. Interaction between chromia forming alloy interconnects and air electrode of solid oxide fuel cells[J]. Solid State Ionics, 1997, 99(3-4): 297-310.

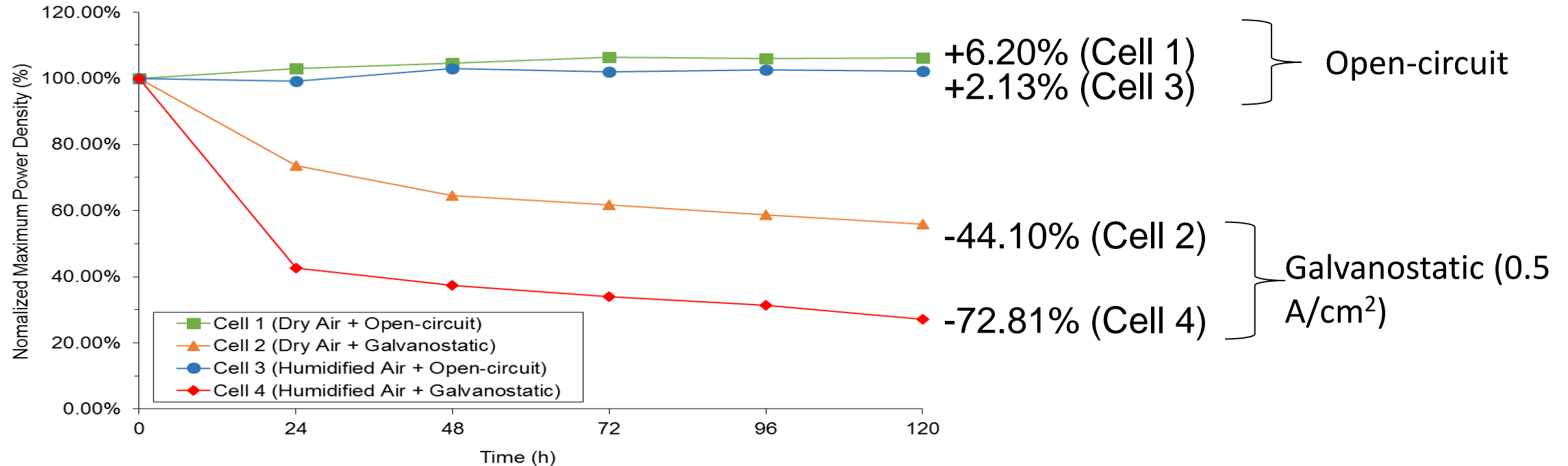
# Post Test Microstructure (Half-Cells)



$$R = \frac{(La_{L\alpha} + Cr_{K\alpha})}{La_{L\alpha}}$$

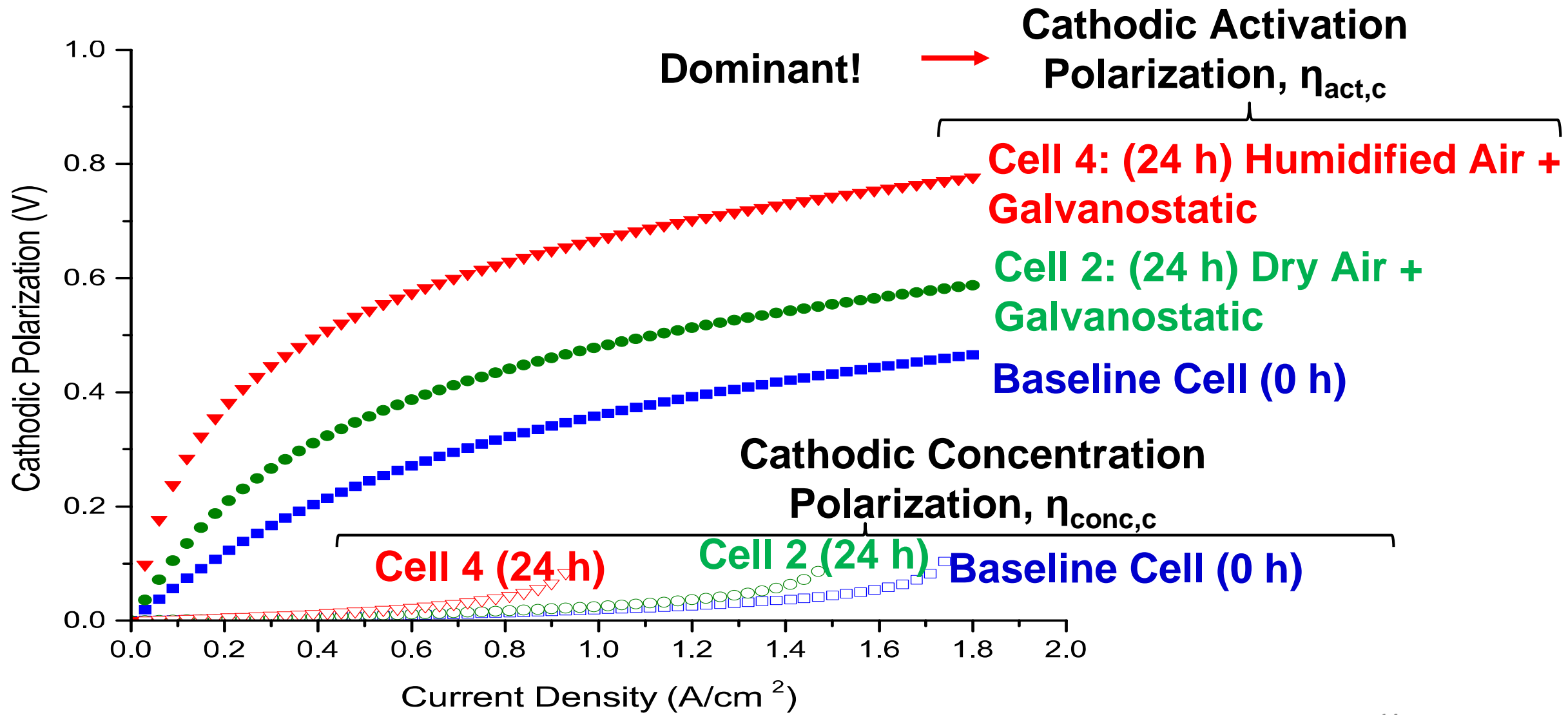
- Cr was detected over the whole electrode under cathodic current and 10% humidified air

# Effect of Current and Humidity (Cathode Polarization): Complete Cells



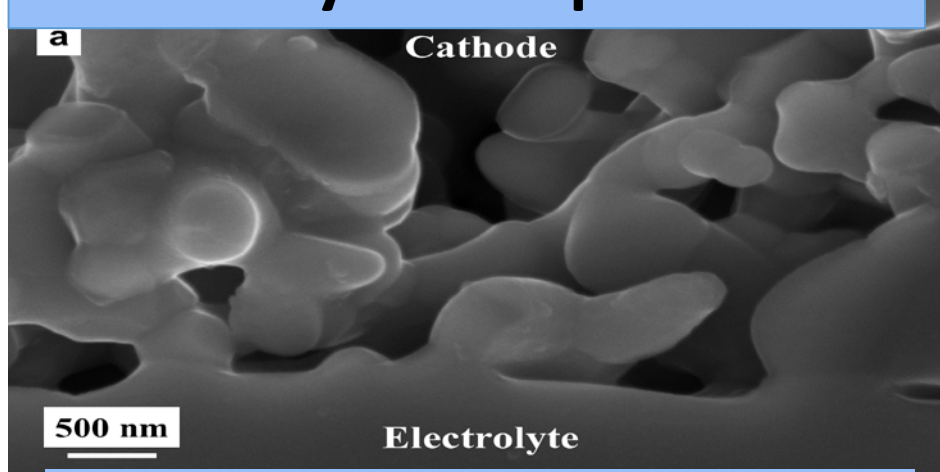
- Rate of degradation: Cell 4 > Cell 2 > Cell 3 ≥ Cell 1
- Degradation appeared to occur significantly when constant current was applied.
- Humidity appeared to promote the performance degradation.

# Cathode Polarization Losses (Complete Cells)

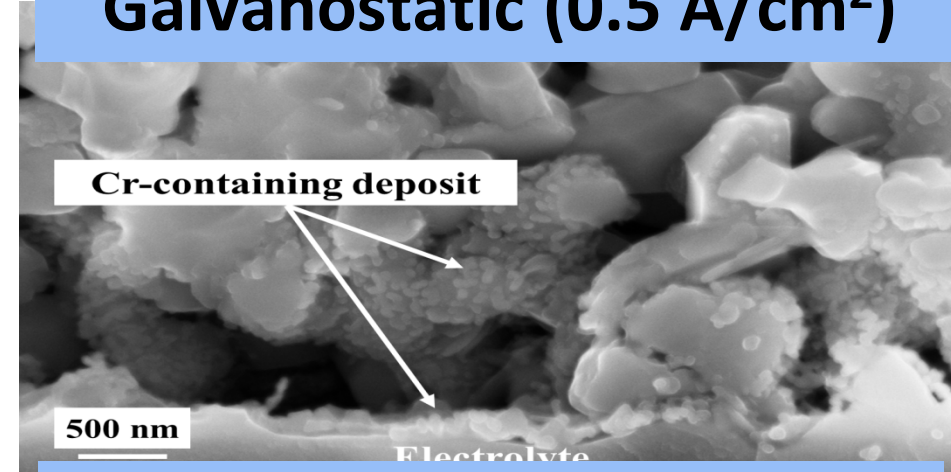


# Post-Test Microstructure Characterization (SEM)

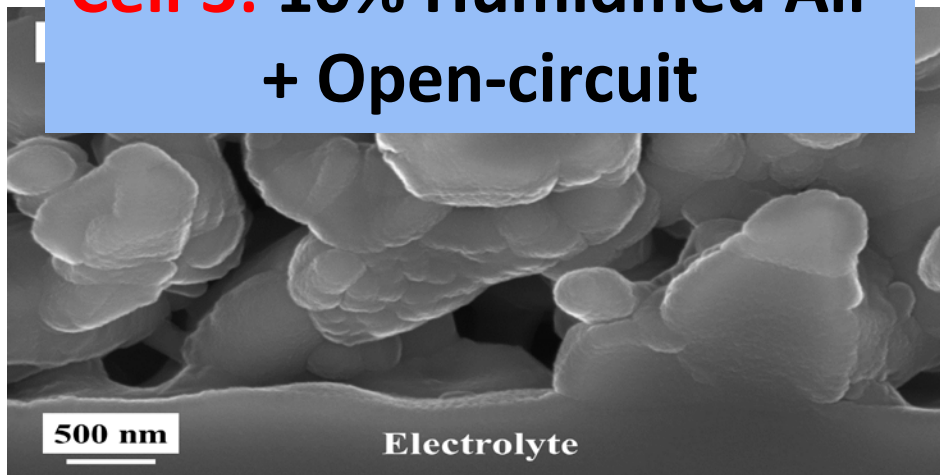
**Cell 1: Dry air + Open-circuit**



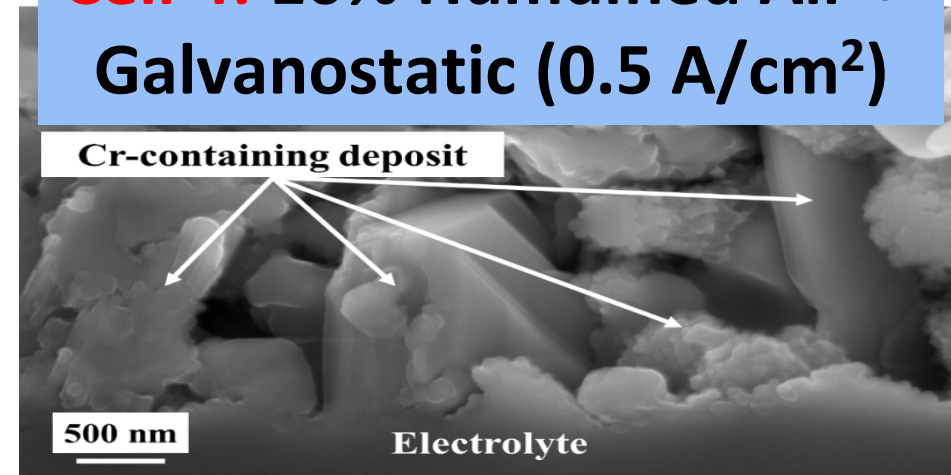
**Cell 2: Dry air + Galvanostatic (0.5 A/cm<sup>2</sup>)**



**Cell 3: 10% Humidified Air + Open-circuit**

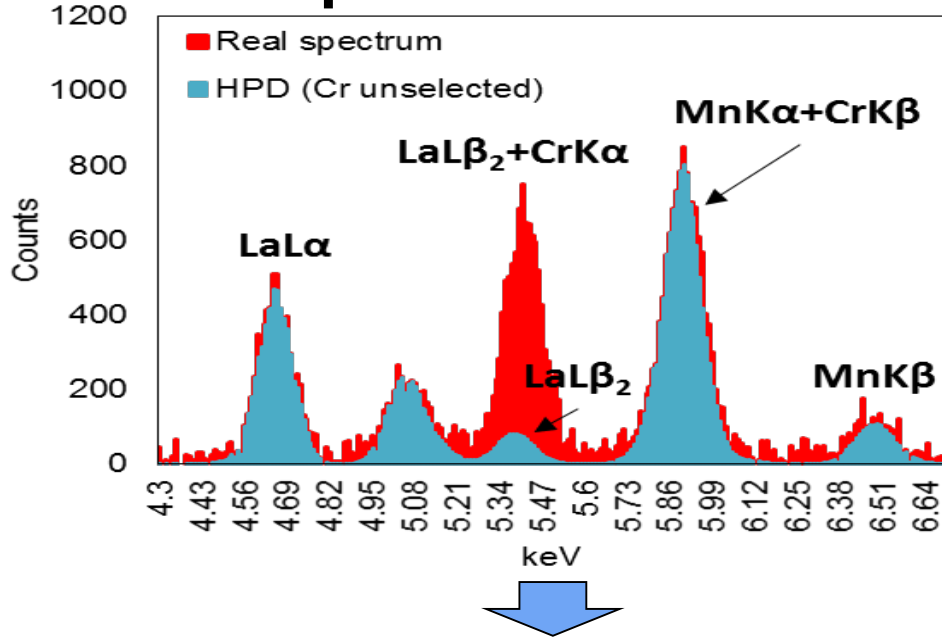


**Cell 4: 10% Humidified Air + Galvanostatic (0.5 A/cm<sup>2</sup>)**



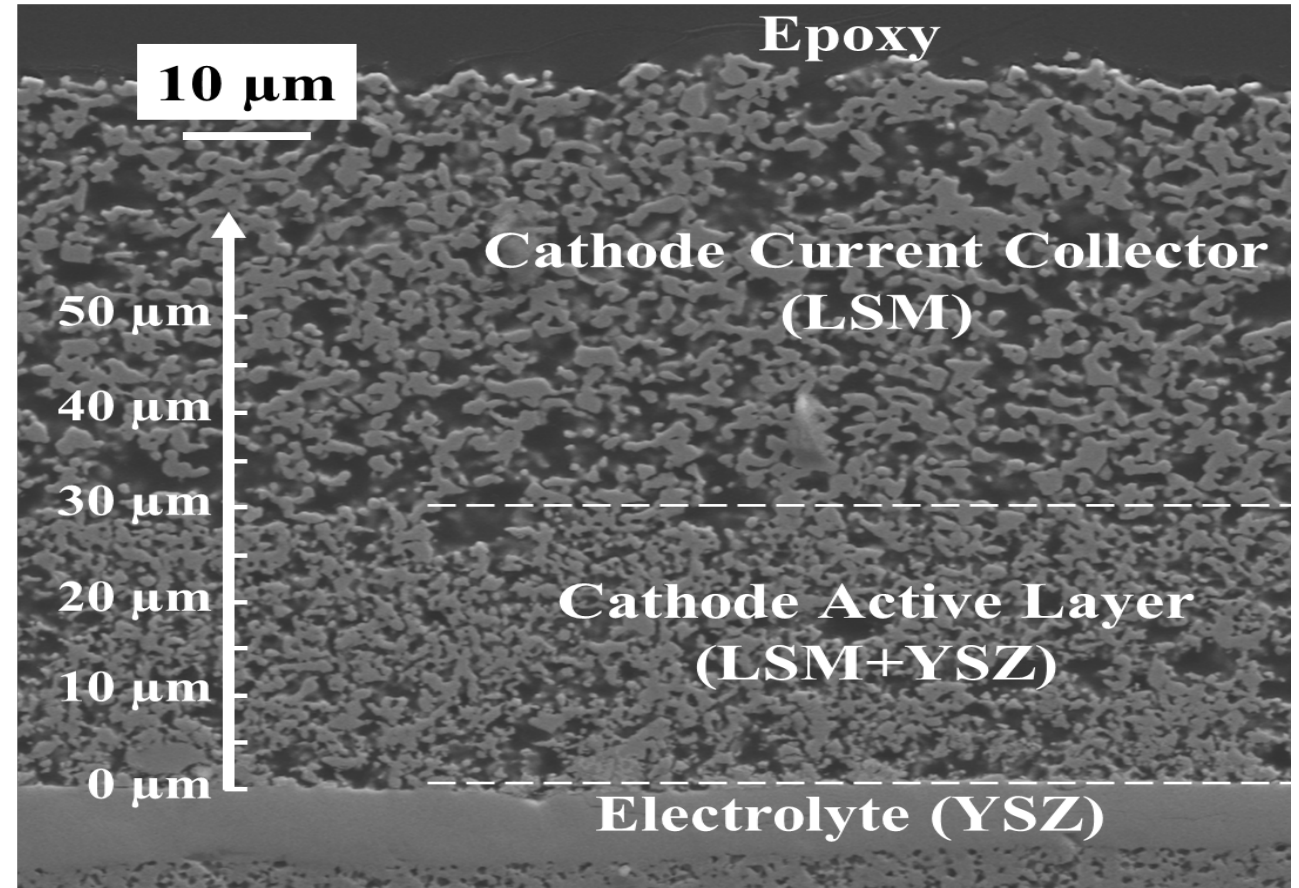
# Post-Test Microstructure Characterization (EDX)

## Example: A Spectrum of Cr-poisoned Cathode



### ❖ Metric for Cr deposition:

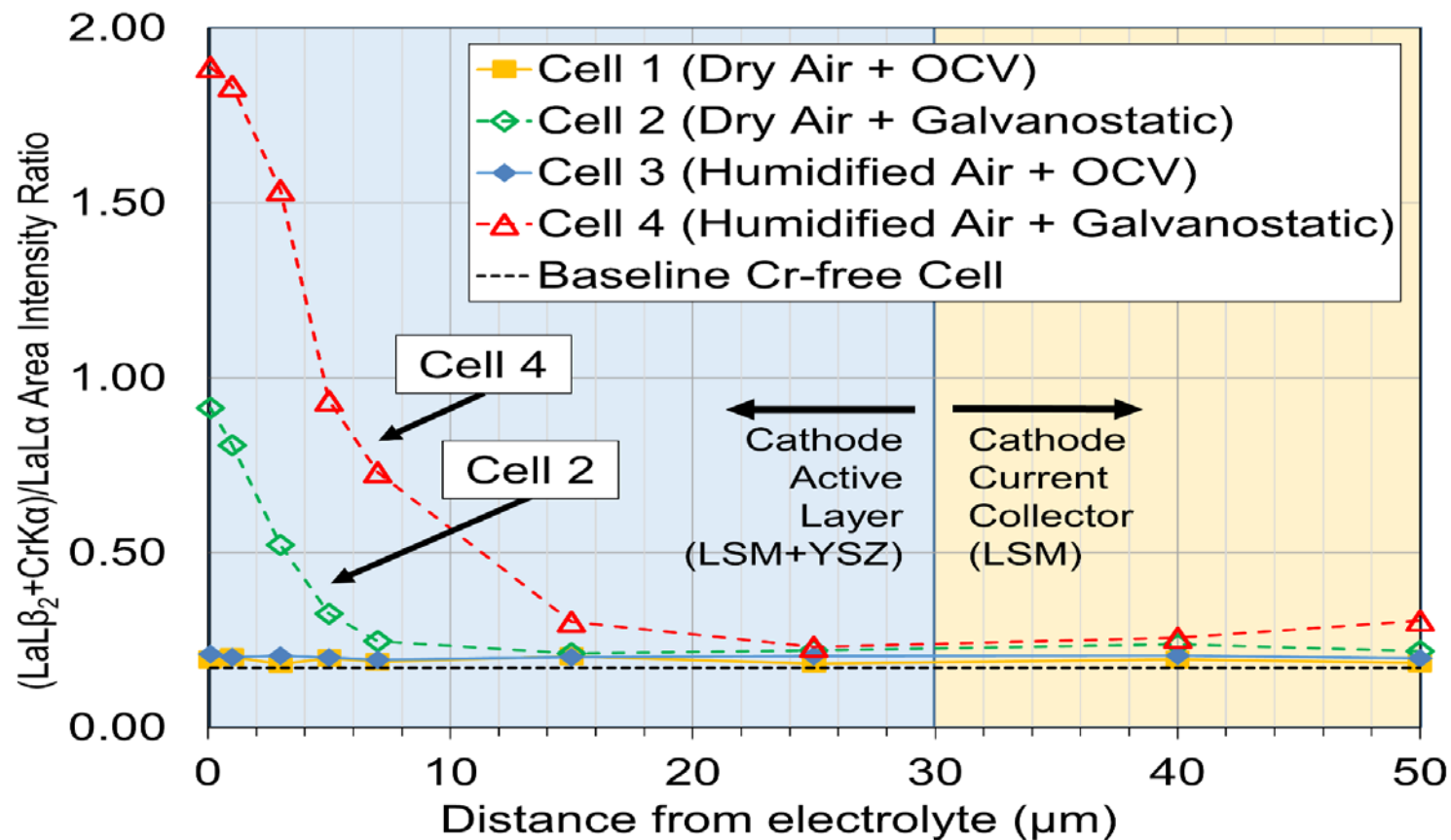
$$\text{Intensity Ratio: } \frac{\text{LaL}\beta_2(+\text{CrK}\alpha)}{\text{LaL}\alpha}$$



Area intensity ratios were measured at different cathode distances from the electrolyte.

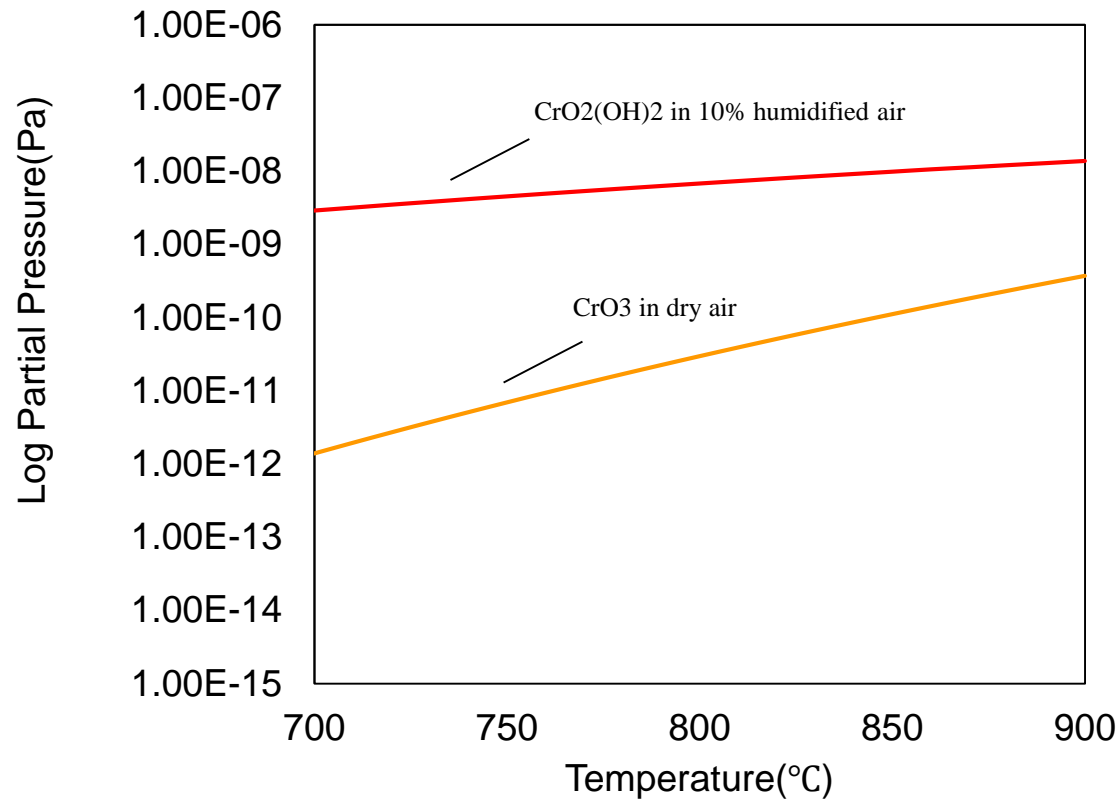


# Post-Test Microstructure Characterization (EDX)



- Cr intensity at cathode/electrolyte interface: Cell 4 > Cell 2 > Cell 3 ≈ Cell 1
- Cr deposition was promoted by current and extended to TPB's away from the electrolyte.

# The Effect of Humidity

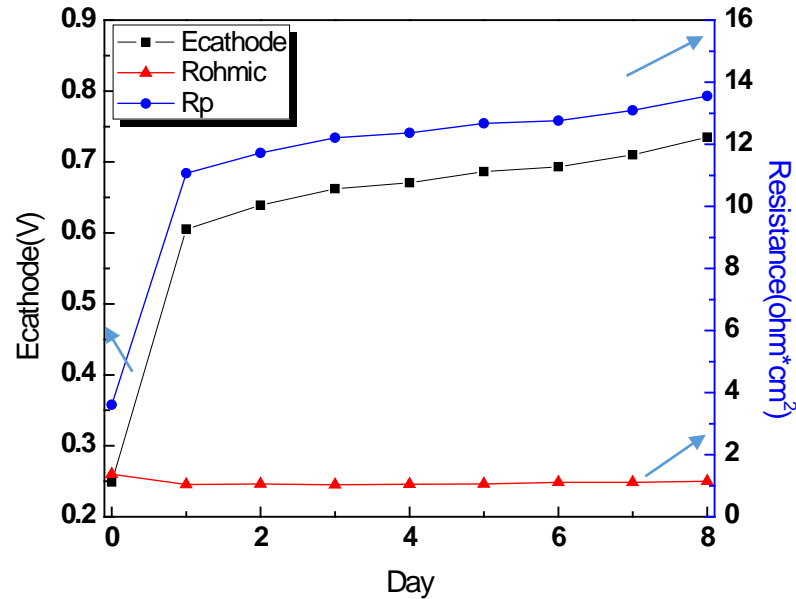


➤ The vapor pressure of the oxy-hydroxide is greater by a factor of 100 to 10000.

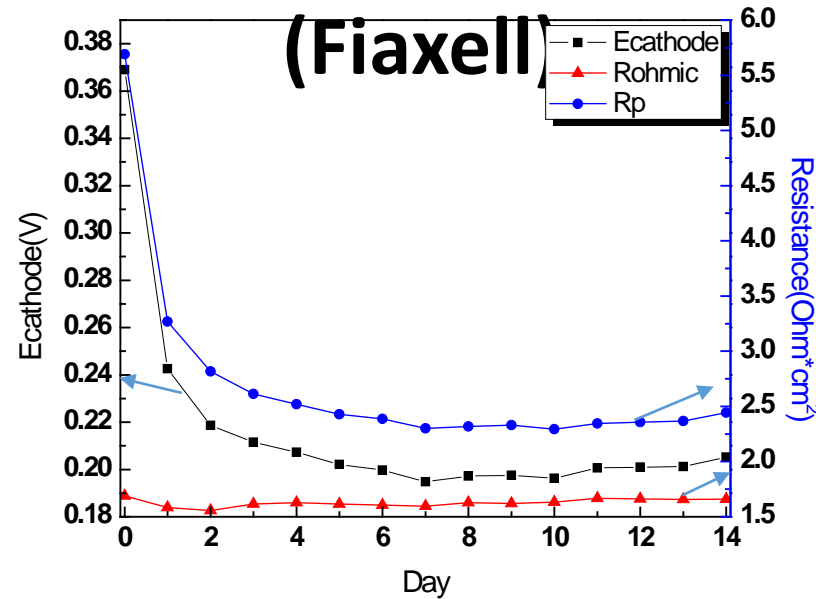
Vapor pressures of major chromium vapor species in air from thermodynamic calculation

# Effect of Protective Coating: Half-Cells

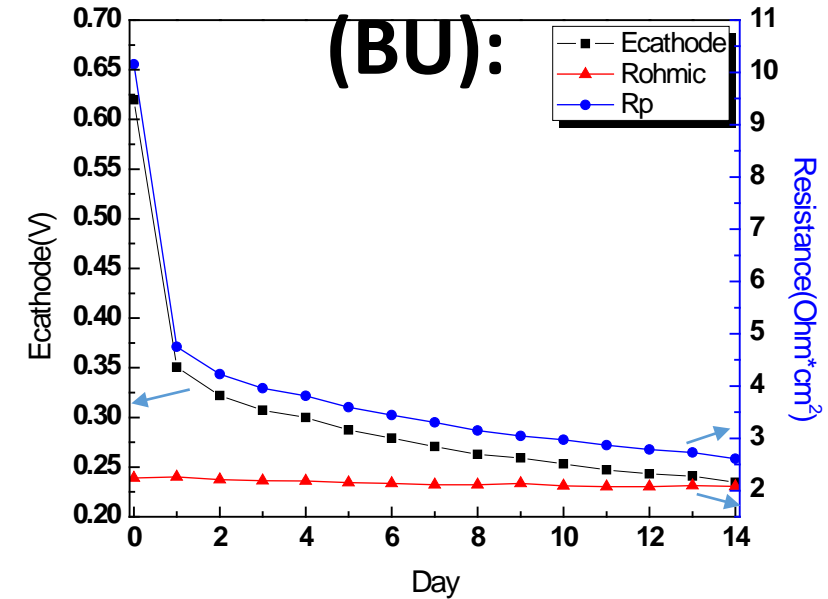
## No coating



## CuMn<sub>2</sub>O<sub>4</sub> coating (Fiaxell)



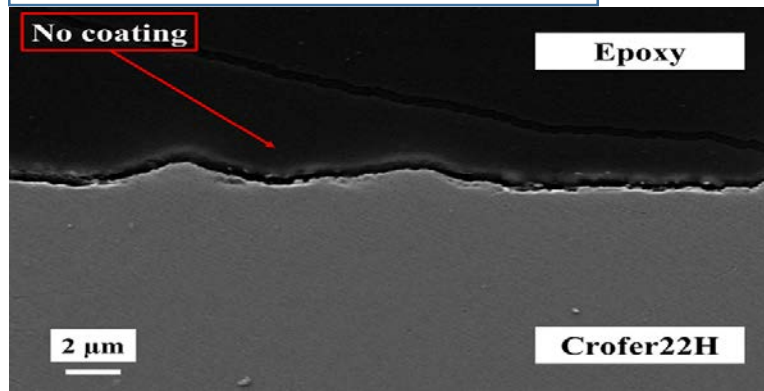
## CuMn<sub>1.8</sub>O<sub>4</sub> coating (BU)



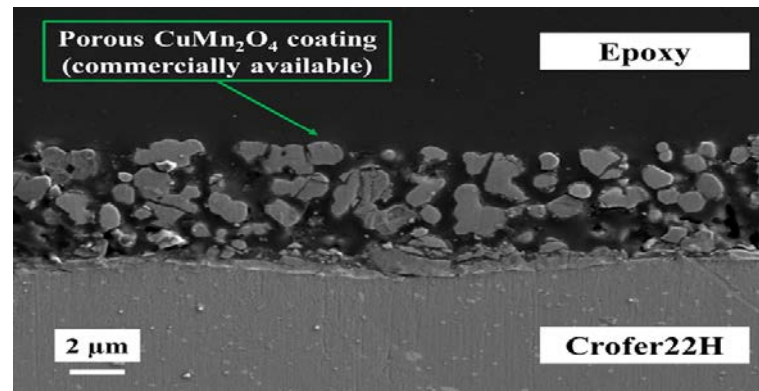
- **No coating** : Major degradation of performance was observed once the cathodic constant current was applied.
- **CuMn<sub>2</sub>O<sub>4</sub> coating (Fiaxell)**: Minor degradation was observed after the 240 hours' current was applied.
- **CuMn<sub>1.8</sub>O<sub>4</sub> coating (BU)**: No degradation was observed during the 14-day test.

# Effects of Protective Coating: Complete Cells

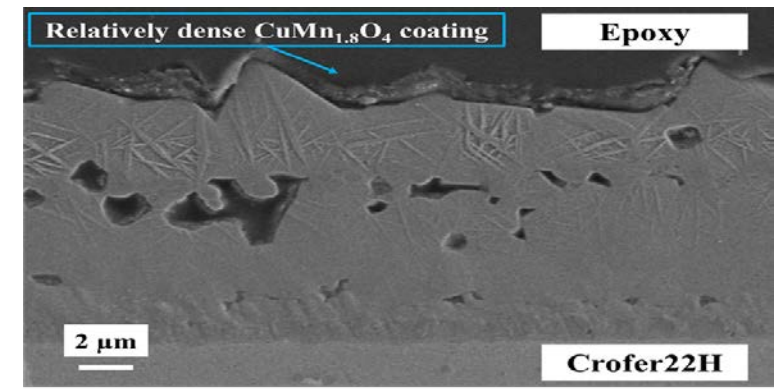
**(a) No Coating**



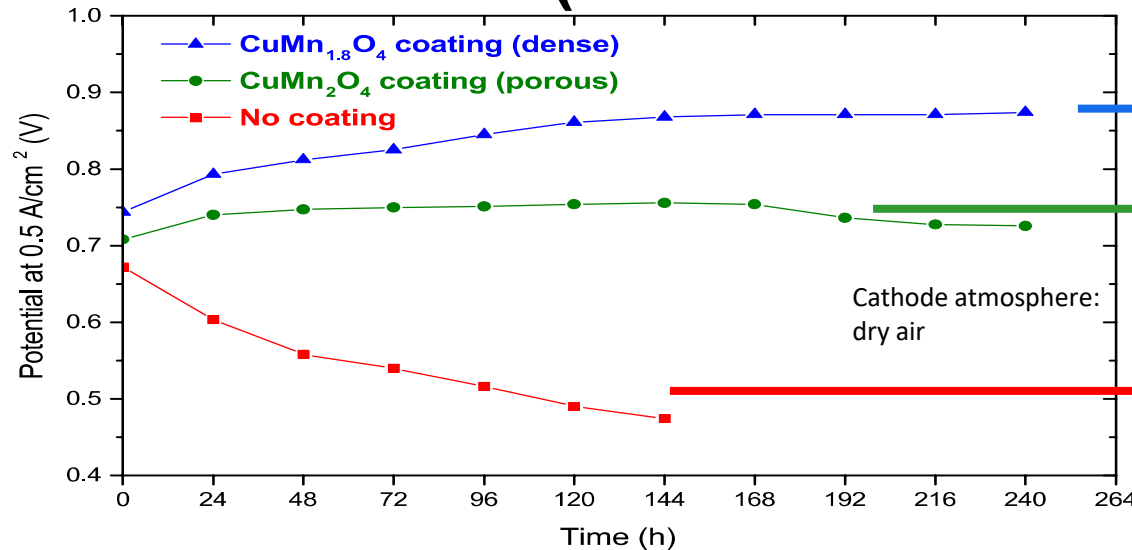
**(b) Commercial (Fiaxell)  $\text{CuMn}_2\text{O}_4$  Spinel Coating**



**(c) BU  $\text{CuMn}_{1.8}\text{O}_4$  Spinel Coating**



## ❖ Cell Performance (Potential at 0.5 A/cm<sup>2</sup>) as a Function of Time:



**No observable degradation**

**Degradation after Cr gettering capacity of coating exhausted**

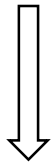
**Degradation was observed from the beginning**

# **Electrophoretic Deposition of Protective Coatings**

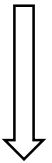
# Electrophoretic Deposition of $\text{CuMn}_{1.8}\text{O}_4$ coatings

## Deposition Process

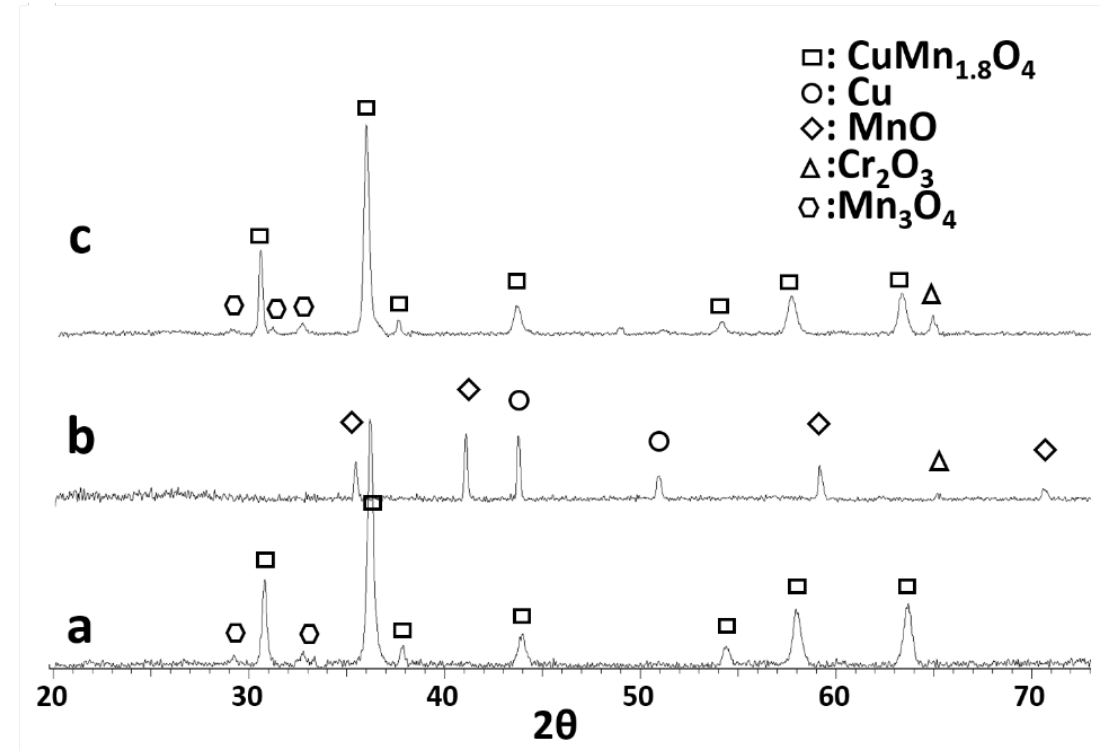
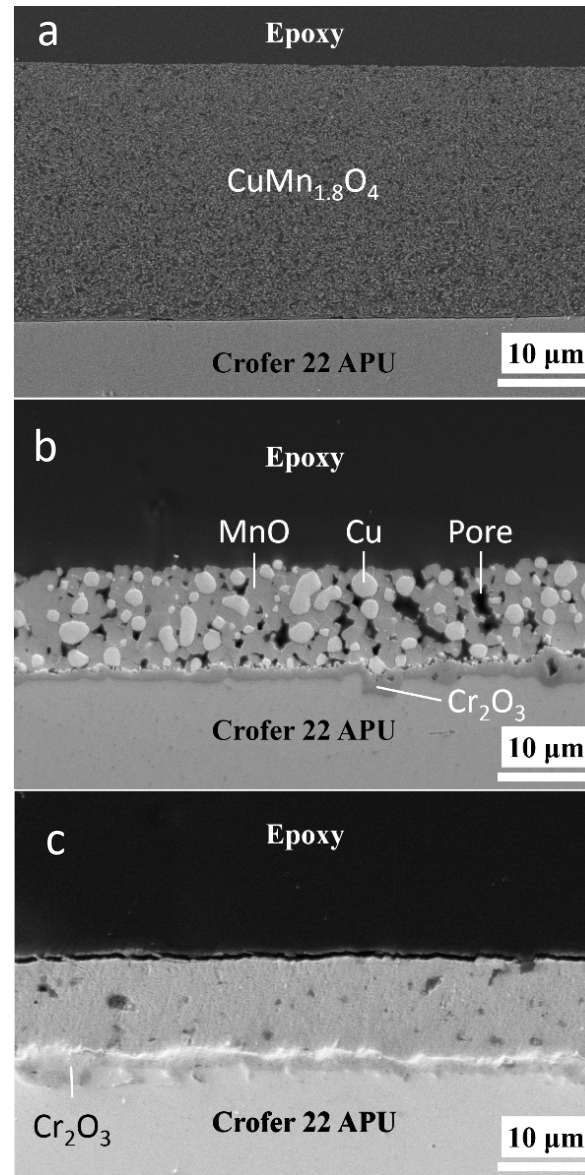
EPD



Reduction annealing  
(1000 °C, 24 h)

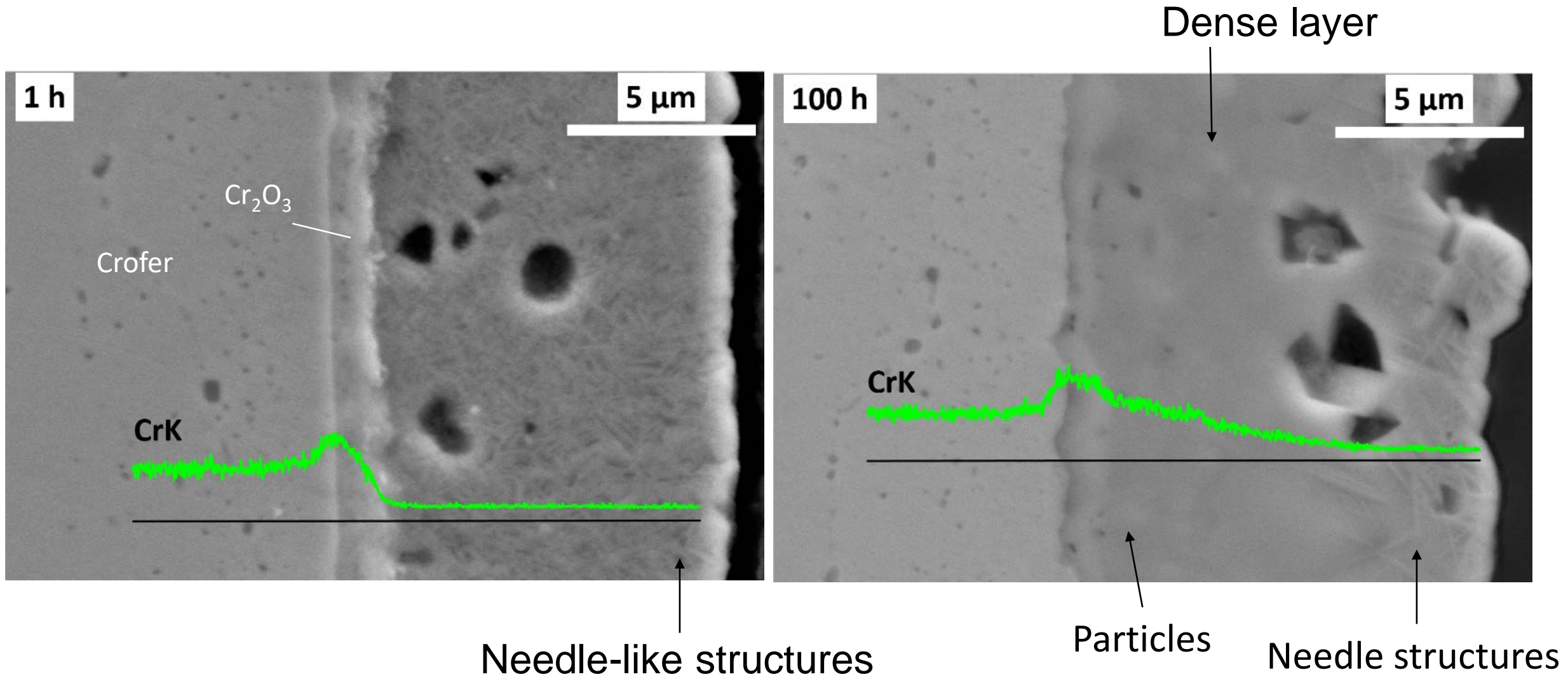


Oxidation annealing  
(850 °C, 1 h)

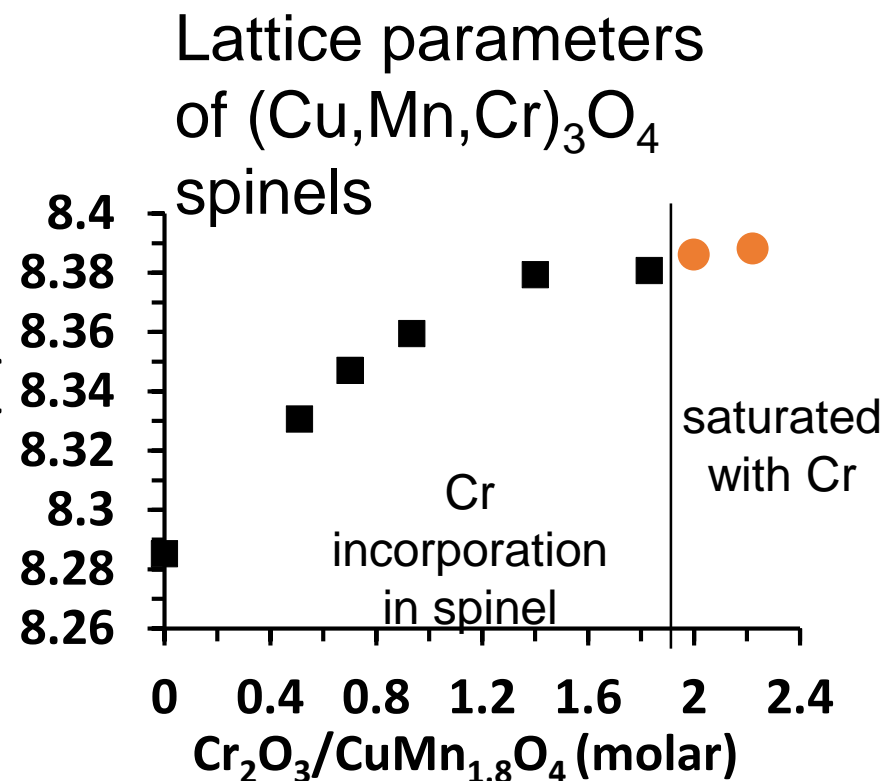
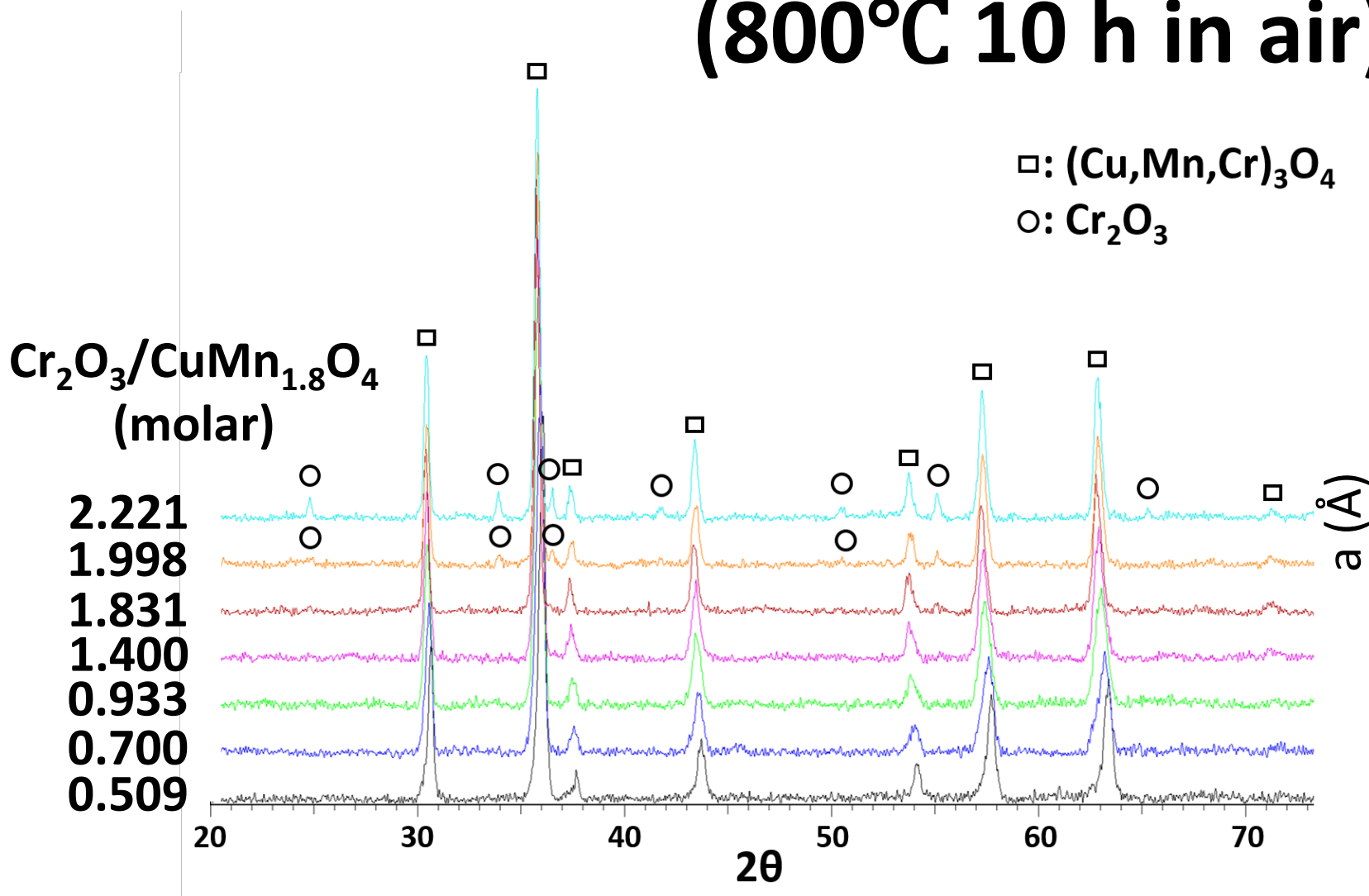


XRD: a)  $\text{CuMn}_{1.8}\text{O}_4$  powders  
b) after reduction anneal  
c) after 1h oxidation anneal

# Microstructure evolution during oxidation at 850°C



# Reaction between $\text{CuMn}_{1.8}\text{O}_4$ and $\text{Cr}_2\text{O}_3$ (800°C 10 h in air)

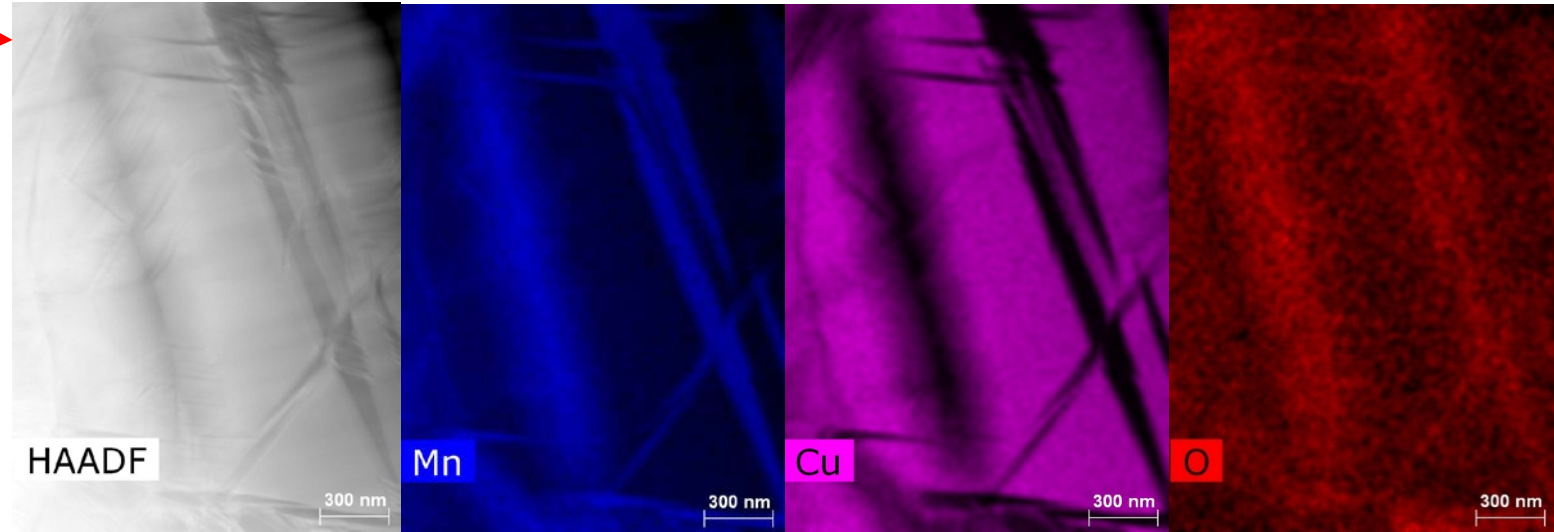
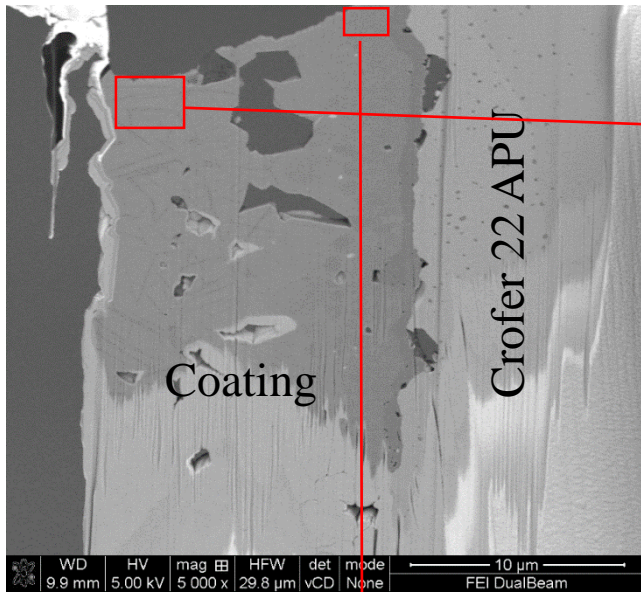


One mole of  $\text{CuMn}_{1.8}\text{O}_4$  can get ~ 2 moles of  $\text{Cr}_2\text{O}_3$



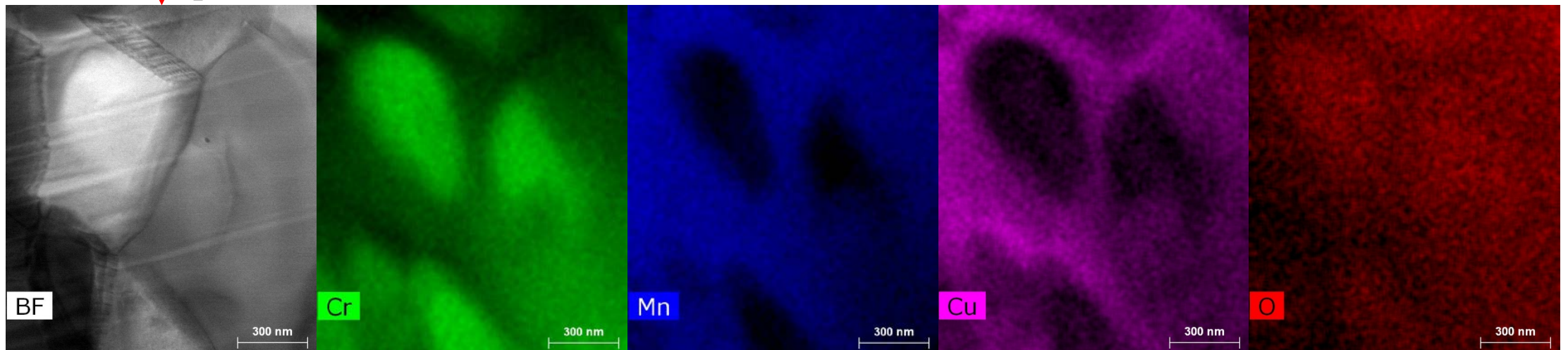
# TEM analysis of coating

Needle structures: Mn-rich

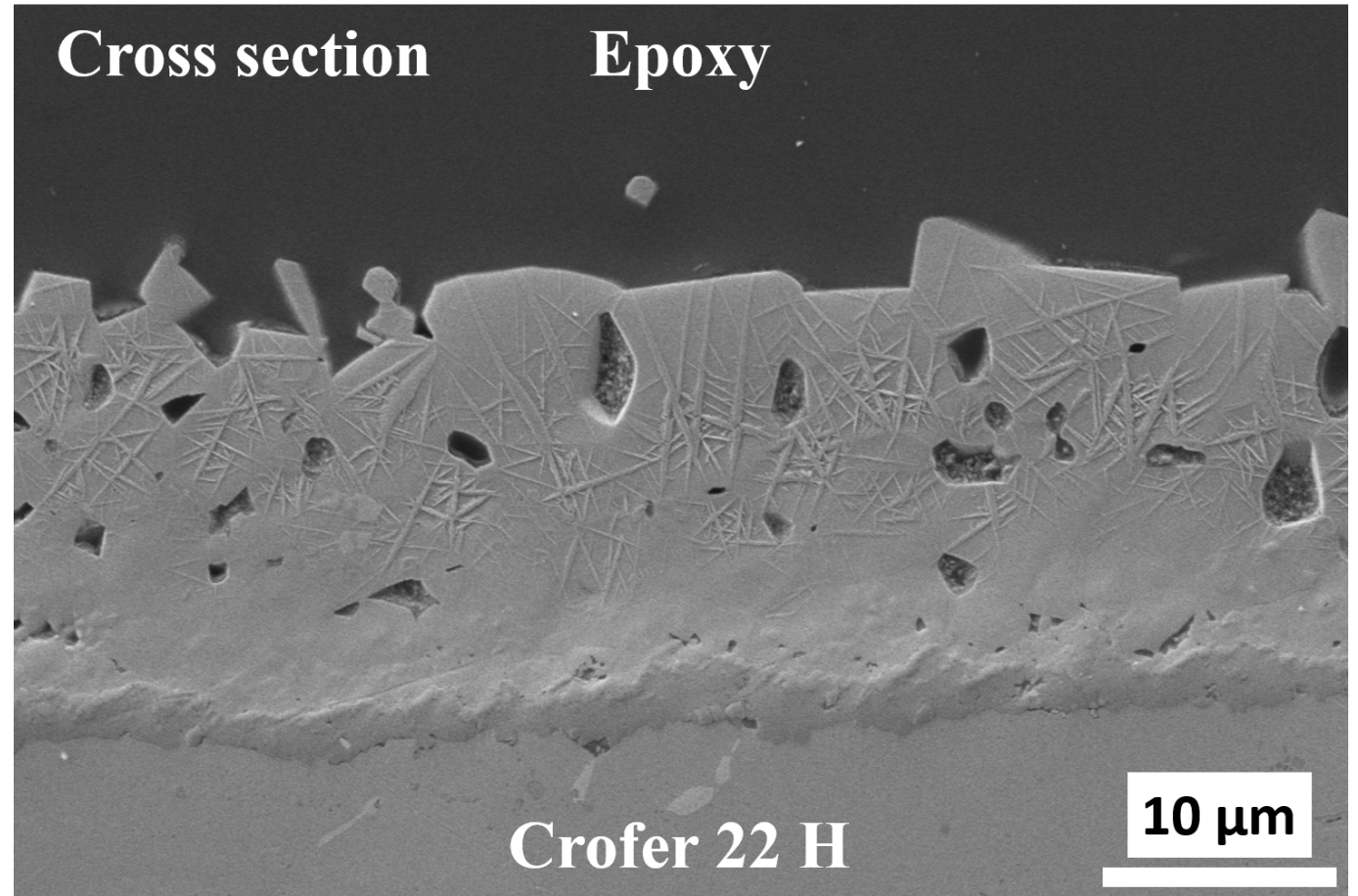
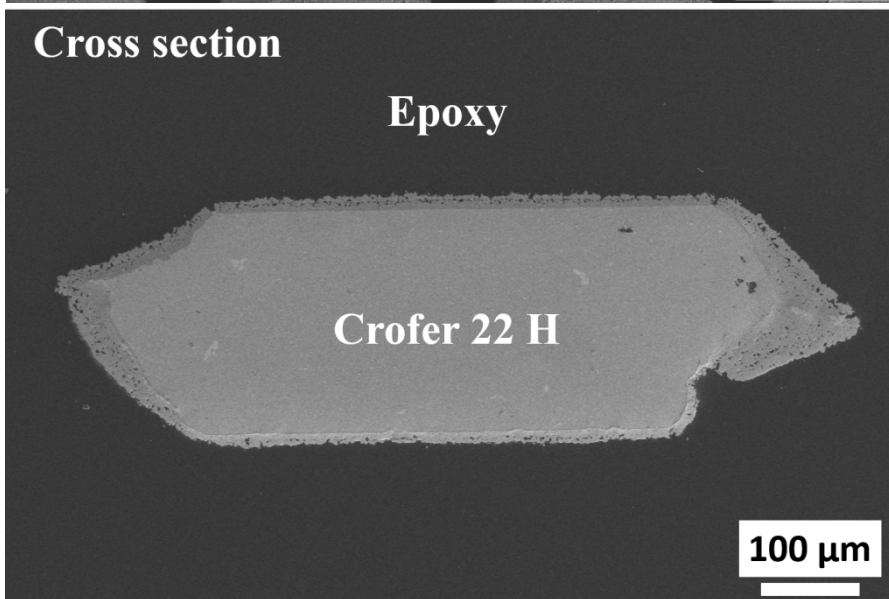
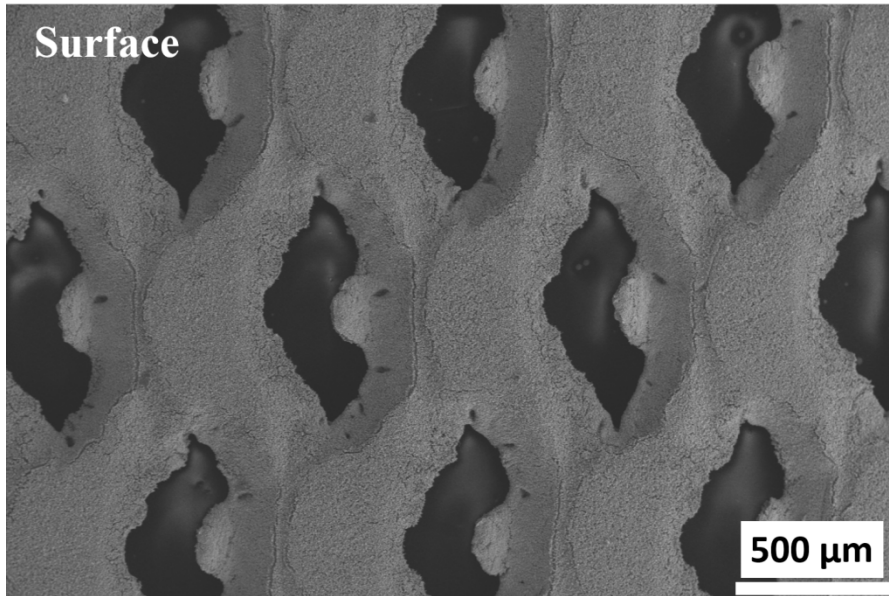


FIB-based cross sectional TEM sample

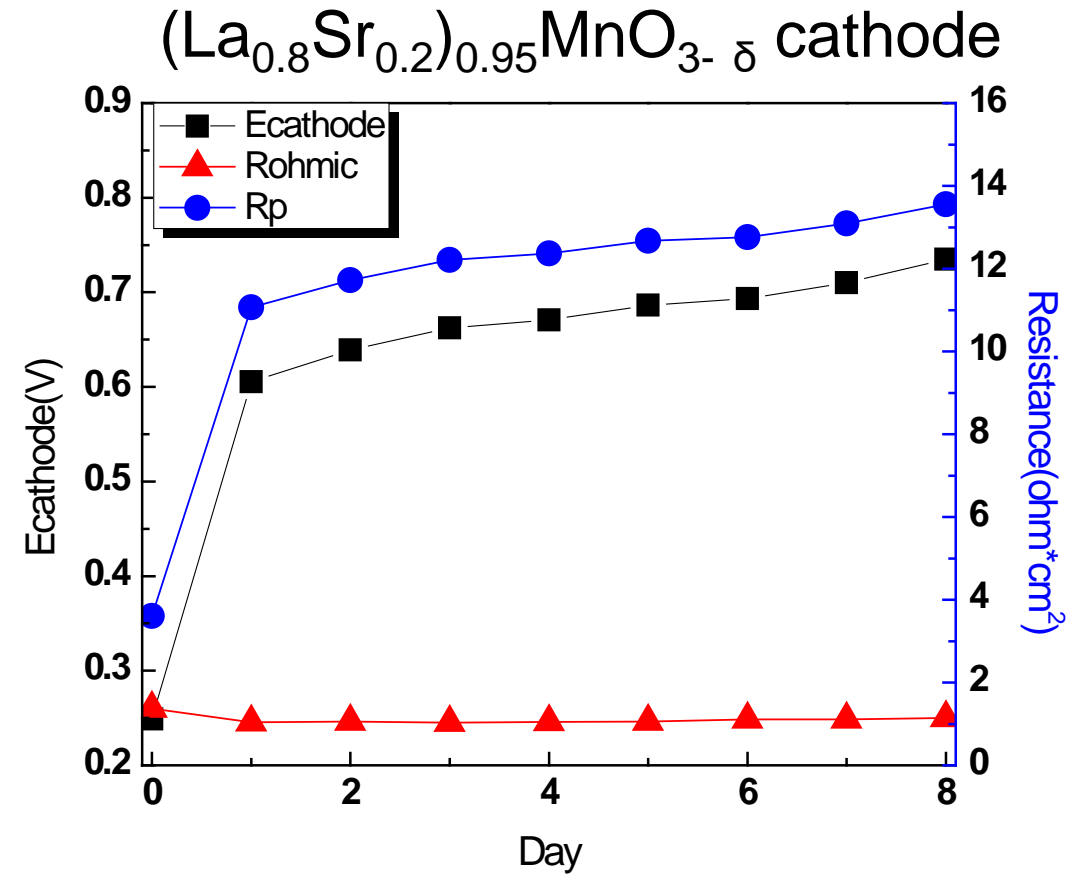
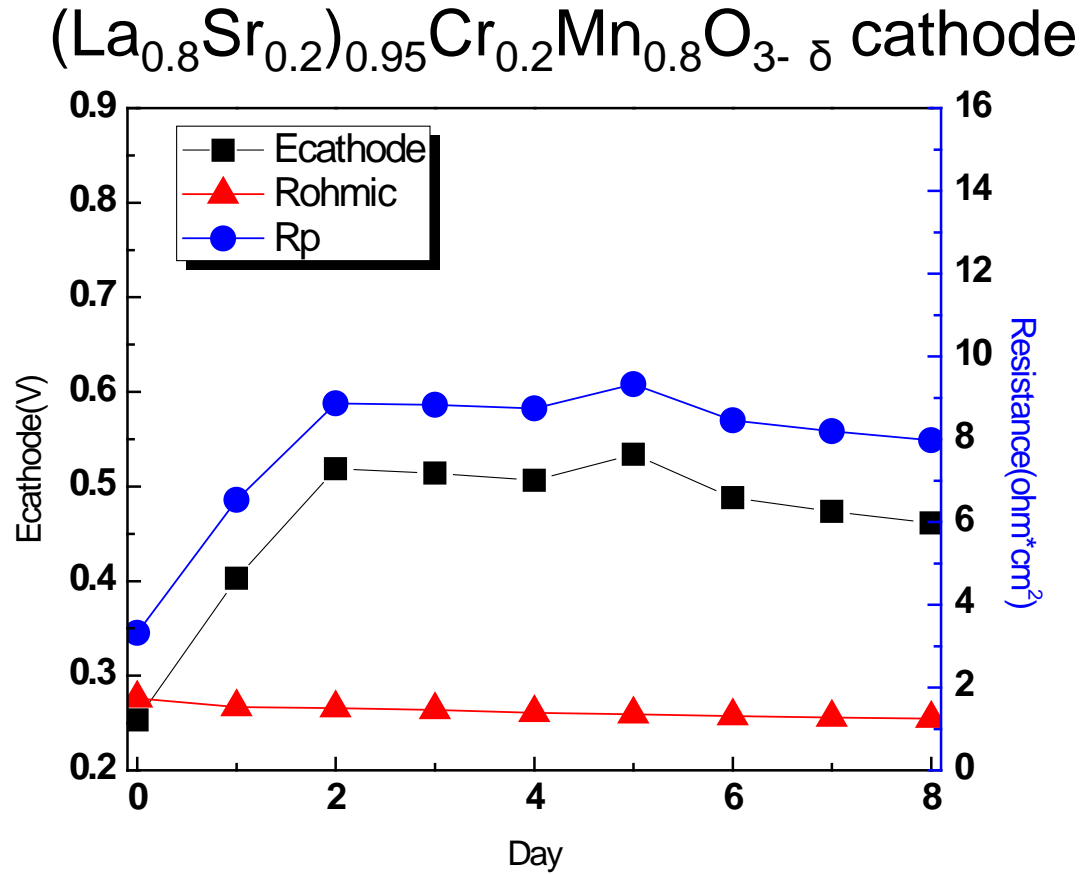
Particles in dense layer:  $\text{Cr}_2\text{O}_3$



# Coating on complex geometry (Crofer mesh)



# Ongoing Work: Cathode Compositional Modifications (Half Cells)



- $(\text{La}_{0.8}\text{Sr}_{0.2})_{0.95}\text{Cr}_{0.2}\text{Mn}_{0.8}\text{O}_{3-\delta}$  cathode: The polarization resistance stabilized after 2 days' cathodic current.
- $(\text{La}_{0.8}\text{Sr}_{0.2})_{0.95}\text{MnO}_{3-\delta}$  cathode : The polarization resistance continued to increase after 8 days' cathodic current.

# Summary and Conclusions

- Cr-impurity attack has been studied using half-cells and complete cells
- Cr-transport and attack occurs not only at TPBs, but also on internal pore surfaces in the cathode
- Attack occurs under cathodic polarization; magnified by humidity
- Can be mitigated/eliminated to a great extent by applying protective coatings on the interconnect
- Effective EPD technique has been developed – possible to apply dense conformal spinel coatings
- Cathode compositional modifications appear promising

# Acknowledgments

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- Useful discussions with Steve Markovich, Rin Burke, and Shailesh Vora at DOE-NETL are acknowledged
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